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Hydroxyl radical-assisted decomposition and oxidation in solution-processed indium oxide thin-film transistors

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Solution-processed indium oxide TFTs were fabricated by hydroxyl radical-assisted (HRA) decomposition and oxidation. The results show that decomposition and oxidation of carbon is more substantial than metal hydroxides, leading to the elimination of organic residues, correlated to a low interface trap density (S.S. = 0.45 V dec⁻¹, $N_T = 1.11 \times 10^{12}$ cm⁻²) in the device. The resultant HRA indium oxide TFTs exhibit improved electrical characteristics such as the mobility, the on/off current ratio, and the subthreshold swing as well as bias stabilities under PBS and NBS conditions.

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Introduction

Their superior optical transparency and excellent charge transport characteristics make amorphous metal oxide semiconductors suitable for applications in flat panel displays and particularly thin-film transistors (TFTs).¹ Vacuum-based deposition techniques are primarily employed to fabricate metal oxide as the channel layers in TFTs.² However, as these vacuum-based techniques are costly from the aspect of machinery,³ solution-based techniques have been proposed as the alternative fabrication method.⁴ In addition, solution processing enables low temperature fabrication, high throughput, and large area deposition for metal oxide TFTs.

Along with the breakthrough of solution-processed metal oxide TFTs, a study on solution-processed heavy post transition metal cations in the form of oxide compounds has also been carried out.⁵ Among oxide compounds that include binary (ZnO, SnO₂, In₂O₃), ternary (InZnO, ZnSnO), and quaternary (InGaZnO) compounds, indium oxide (In₂O₃) is one of the most studied materials as channel layers due to its high mobility of ~10–65 cm² V⁻¹ s⁻¹.⁶ Despite reports on high mobility,^{7–12} one challenge of In₂O₃ as the channel layer of the TFT is its volatility to poor bias durability due to high charge defects. These charge defects include metal interstitials, oxygen deficiencies, and carbon impurities. For In₂O₃, oxygen deficiency formation is inevitable owing to its low formation energy,¹³ and therefore oxygen binders such as Hf, W, and Si must be doped to achieve a low trap density which leads to high quality In₂O₃-based films.^{14,15} The addition of dopants requires higher annealing temperatures to achieve a satisfactory level of field effect

mobility as that of undoped In₂O₃. It is therefore advantageous to produce In₂O₃ TFTs without using dopants to maintain low annealing temperatures. However, obtaining In₂O₃ TFTs with high field effect mobility combined with excellent bias stability at low annealing temperatures as well as without metal dopants remains a challenge.

Herein, we demonstrate the fabrication of In₂O₃ TFTs using hydroxyl radical-assisted (HRA) decomposition and oxidation. The generation of hydroxyl radicals was accomplished by incorporating and activating hydrogen peroxide in the In₂O₃ precursor solution. Different from our previous study which focused on general hydrogen peroxide doping,¹⁶ this study focuses on hydroxyl radical-assisted decomposition and oxidation. Moreover, we employ a significantly lower annealing temperature suitable for flexible substrates. By using the HRA method, we successfully produce In₂O₃ films with low trap sites and TFT characteristics exhibiting excellent field effect mobility and stabilities at a low temperature of 240 °C. In this report, we discuss the HRA decomposition and oxidation of In₂O₃ TFTs and characterize their electrical performance and stabilities.

Experimental

A 0.3 M indium oxide solution was made by dissolving indium nitrate hydrate (In[NO₃]₃·xH₂O) in 10 mL of 2-methoxyethanol (2ME). Then, nitric acid (HNO₃) was added. The precursor solution was stirred at 320 rpm for 4 hours and maintained at a temperature of 60 °C to create a homogeneous and transparent solution. Following that, the prepared solution was filtered through a 0.2 μm micro filter and spin-coated at 3000 rpm onto a substrate to form the active layer of thin-film

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transistors (TFTs). A total of four samples were prepared: (1) pristine In_2O_3 , (2) $\text{In}_2\text{O}_3\text{-H}_2\text{O}_2$, (3) $\text{In}_2\text{O}_3\text{-HRA}$, and (4) $\text{In}_2\text{O}_3\text{-UV}$. For pristine In_2O_3 TFTs, the solution is coated as it is. For $\text{In}_2\text{O}_3\text{-H}_2\text{O}_2$ TFTs, 30% volume hydrogen peroxide (H_2O_2) was dispersed in pristine In_2O_3 solution. For $\text{In}_2\text{O}_3\text{-HRA}$ TFTs, $\text{In}_2\text{O}_3\text{-H}_2\text{O}_2$ films were irradiated for 30 minutes with ultraviolet (UV) lamps with wavelengths of 185 nm and 254 nm at an intensity of 60 mW cm^{-2} to generate hydroxyl radicals (OH^\bullet). To exclude the effect of UV light, pristine In_2O_3 was also irradiated following the same UV illumination procedure, herein referred to as $\text{In}_2\text{O}_3\text{-UV}$. All fabricated TFTs employed a bottom-gate, top-contact configuration. $\text{SiO}_2/\text{p}^+\text{-Si}$ substrates (120 nm) were used as gate dielectrics/gate. The coated active layer was annealed at 240°C for 4 hours on a hot plate in ambient air. The source and drain electrodes (Al, 100 nm) were then deposited using a thermal evaporator with a shadow mask. The channel of the fabricated TFT devices was $1000 \mu\text{m}$ wide and $150 \mu\text{m}$ long.

Current–voltage ($I\text{-}V$) characteristics of TFTs were measured at room temperature in a dark room using an HP4156C semiconductor parameter analyzer. Bias stability (positive bias stability, PBS; and negative bias stability, NBS) was recorded under the constant positive (+20 V) and negative (−20) gate bias for 1000 s at room temperature. V_{DS} was set to 10.1 V and V_{G} was swept from −30 V to 30 V to measure the stability. Chemical compositions of the oxide films were determined by Attenuated Total Reflection Fourier Transform Infrared (ATR-FTIR, Bruker Vertex 70) spectroscopy, X-ray Photoelectron Spectroscopy (XPS, Thermo VG Scientific), and Electron Spin Resonance (ESR, Bruker BioSpin) spectroscopy. The FTIR data were measured in reflection mode at a resolution of 4 cm^{-1} . The XPS data were recorded using a monochromatic Al K source (1486.6 eV) in an ultra-high vacuum system at a base pressure of $\sim 10^{-10}$ Torr. The C 1s peak at 284.8 eV was used for calibration. For ESR spectroscopy, spin-trapping was used due to the low concentration and the transient nature of the radicals.

5,5-Dimethyl-1-pyrroline *N*-oxide (DMPO) was chosen as a spin trap agent because of its well-documented trapping ability and selectivity for radicals.^{17–19}

Results and discussion

The schematic illustration of the HRA decomposition and oxidation method is shown in Fig. 1a. OH^\bullet can be generated through UV irradiation because H_2O_2 absorbs wavelengths $\leq 350 \text{ nm}$ subsequently causing photolytic cleavage to yield OH^\bullet .^{19–21} The irradiation generates two OH^\bullet per molecule of H_2O_2 as shown in eqn (1). In this photocatalytic reaction, OH^\bullet was produced as main species through photocatalysis.



Fig. 1b displays the transfer characteristics of pristine In_2O_3 , $\text{In}_2\text{O}_3\text{-UV}$, $\text{In}_2\text{O}_3\text{-H}_2\text{O}_2$, and $\text{In}_2\text{O}_3\text{-HRA}$ TFTs, and Table 1 summarizes their representative electrical parameters. The electrical parameters were extracted from transfer curves in the saturation regime using the transconductance (g_{m}) method:

$$I_{\text{DS}} = \left(\frac{C_i \mu_{\text{FE}} W}{2L} \right) (V_{\text{GS}} - V_{\text{TH}})^2 \text{ for } V_{\text{DS}} > V_{\text{GS}} - V_{\text{TH}} \quad (2)$$

where W is the channel width, L is the channel length, and C_i is the capacitance per unit area of the dielectric layer. HRA decomposition and oxidation results in the most decrease of the trap density and distinctly higher mobility with a better on/off current ratio. As the trap density (N_{T}) was calculated from the subthreshold swing (S.S.), the decrease in the trap density also correlates to the improvement in the S.S. performance. In contrast, incorporation of energetic (4.88–6.70 eV) UV illumination without OH^\bullet may not decrease trap sites as shown for the $\text{In}_2\text{O}_3\text{-UV}$ device. It is therefore commonly accepted that excess

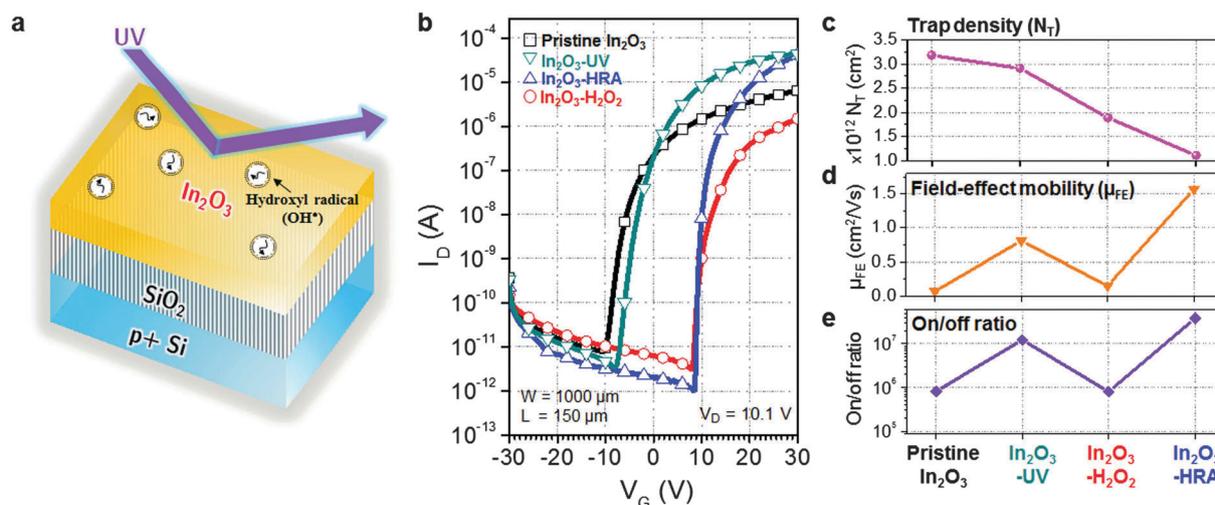


Fig. 1 (a) Schematic of a hydroxyl radical-assisted (HRA) method for solution-processed In_2O_3 thin-films. (b) Transfer characteristics of bottom-gate, top-contact In_2O_3 TFTs with the channel width $W = 1000 \mu\text{m}$ and the channel length $L = 150 \mu\text{m}$. (c) Trap density, (d) field-effect mobility, and (e) the on/off ratio of the In_2O_3 TFTs.



Table 1 Summary of electrical parameters of solution-processed In₂O₃ TFTs

Devices	Mobility (cm ² V ⁻¹ s ⁻¹)	S.S. (V dec ⁻¹)	N _T (cm ⁻²)	On/off ratio
Pristine In ₂ O ₃	0.07	1.17	3.18 × 10 ¹²	8.13 × 10 ⁵
In ₂ O ₃ -UV	0.81	1.08	2.91 × 10 ¹²	1.23 × 10 ⁷
In ₂ O ₃ -H ₂ O ₂	0.15	0.72	1.89 × 10 ¹²	8.02 × 10 ⁵
In ₂ O ₃ -HRA	1.57	0.45	1.11 × 10 ¹²	3.88 × 10 ⁷

trap sites may occur due to the high excitation energy and ozone formation from UV illumination. The result implies that the HRA method both effectively reduces defects related to trap sites and sub-gap states and enhances the electrical characteristics such as the mobility, the on/off current ratio, and the S.S.

To verify the trap density reduction behavior, bias stabilities of pristine In₂O₃, In₂O₃-H₂O₂, and In₂O₃-HRA TFTs were investigated under PBS and NBS conditions (Fig. 2). The In₂O₃-HRA TFT showed a shift of 0.46 V upon the PBS and 0.65 V upon the NBS after 1000 s. The instability of electrical properties under bias stress can be explained by two general mechanisms: (1) the defect creation model and (2) the charge trapping model. In the defect creation model, V_{ON} shifts with deterioration of S.S. as a result of gate bias stress that induces formation of trap sites. In the charge trapping model, on the

other hand, V_{ON} shifts without deterioration of S.S. It is widely believed that the V_{ON} shift (ΔV_{ON}) is contributed by charges trapped at the dielectric/channel interface and inside the bulk of the channel, resulting in ΔV_{ON} without a significant change in S.S. The charge trapping model is related to ΔV_{ON} (ΔV_{ON} = V_{ON,Final} - V_{ON,Initial}) and stress time using the stretched-exponential equation:^{22,23}

$$\Delta V_{ON} = \Delta V_{ON0} [1 - \exp\{- (t/\tau)^\beta\}] \quad (3)$$

where V₀ is the V_{ON} at the start of the experiment, τ is the characteristic trapping time of electron carriers, t is the stress duration time, and β is T/T₀. As shown in Fig. 2, transfer curves of the In₂O₃-HRA TFT show no degradation of S.S. and only a small parallel shift. This result indicates that the In₂O₃-HRA TFT shows prominent improvements under both PBS and NBS conditions compared to the pristine In₂O₃ device owing to reduced trap sites.

In general, the trap sites in solution-processed oxide TFTs are intimately related to defects that inherently exist in the metal oxide channel layer. These defects include impurities and oxygen deficiencies. The presence of carbon impurities is inevitable because of the organic nature of the solvent. It is important to eliminate organic molecules to the highest possible degree because they can trap electrons, and are therefore detrimental

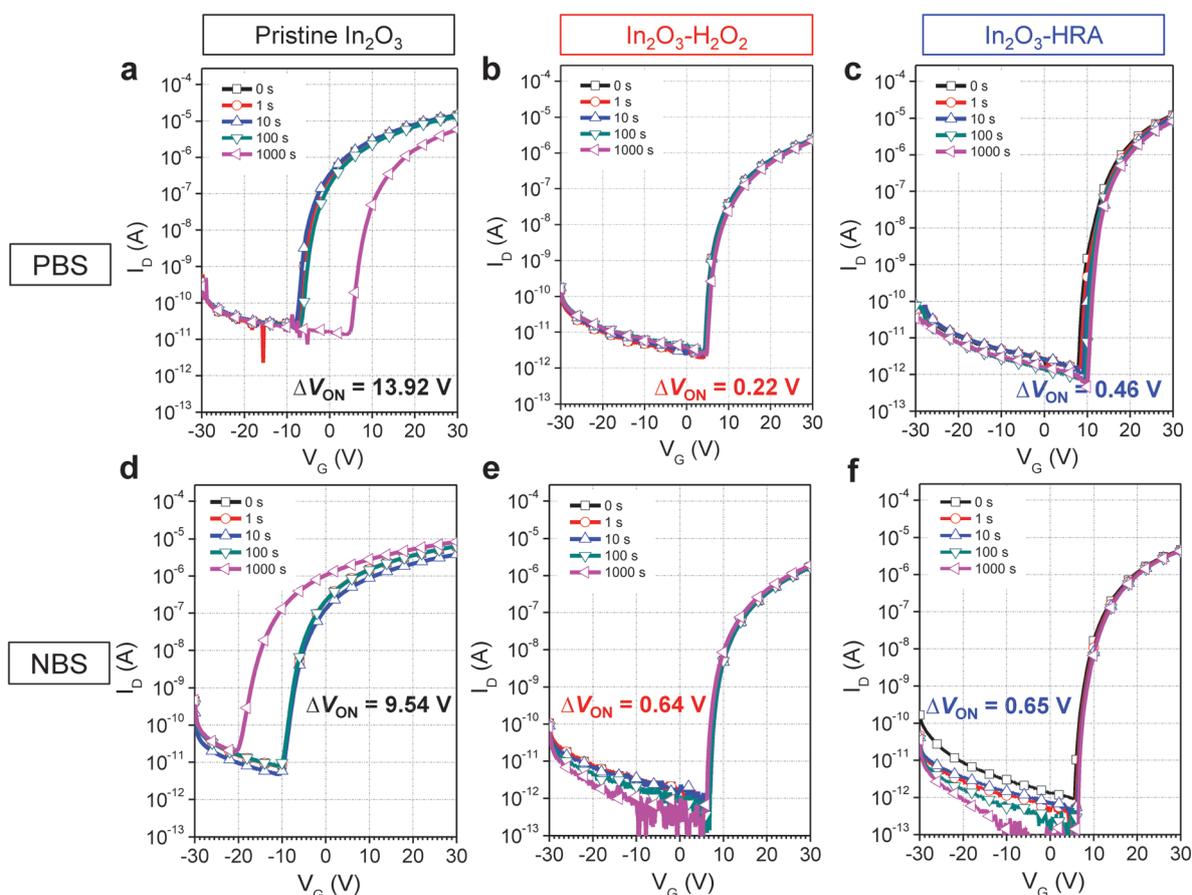


Fig. 2 Evaluation with positive bias stress (a–c) and negative bias stress (d–f) for pristine In₂O₃, (a) and (d); In₂O₃-H₂O₂, (b) and (e); and In₂O₃-HRA, (c) and (f); with a gate voltage of 20 V and -20 V respectively for 1000 s.



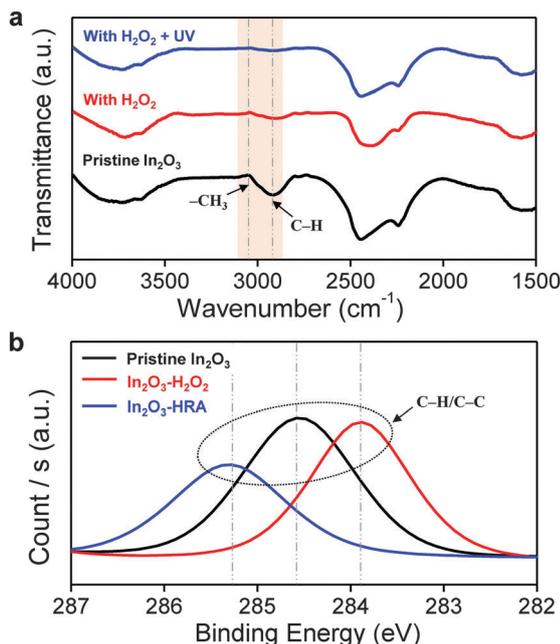


Fig. 3 Profile of (a) FTIR spectra and (b) XPS C 1s spectra of pristine In₂O₃, In₂O₃-H₂O₂, and In₂O₃-HRA films.

to device operation.²⁴ In this regard, the reduction of carbon impurities in the In₂O₃-HRA film was confirmed by FTIR (Fig. 3a) and XPS (Fig. 3b). In Fig. 3a, the C-H peak in the range 2950–2900 cm⁻¹ and the CH₃ peak in the range 3100–3000 cm⁻¹ were absent.^{25,26} The absence of these bands implies a pronounced elimination of carbon impurities in the thin film. Similarly, in the C 1s spectra (Fig. 3b), the characteristic peak corresponding to the C-H/C-C peak (~285 ± 0.6 eV) shows the lowest concentration for the In₂O₃-HRA film.²⁷ Furthermore, the total atomic ratio for carbon summarized in Fig. 5a indicates that impurities were reduced from 21.86% to 16.64% for the HRA method. These results verify the reduction of carbon impurities in the final HRA thin film.

The XPS O 1s peaks of pristine In₂O₃, In₂O₃-H₂O₂, and In₂O₃-HRA TFTs are shown in Fig. 4. The O 1s peaks are deconvoluted to 530.7 eV (green lines), 531.8 eV (blue lines), and 532.9 eV (orange lines) denoting oxygen bonded to metals (M-O), oxygen deficiencies (V_O), and surface hydroxyl species (M-OH) respectively.^{28,29} The HRA In₂O₃ films exhibit a lower degree of hydroxyl species, as expected, despite an increase in oxygen deficiencies. As hydroxide lattices are less efficient in transporting carriers due to broken short intercation distances, it is desirable to reduce M-OH to the lowest possible degree. For In₂O₃, formation energy of V_O is reportedly lower than that of M-O.¹³ In the HRA method, molecular oxygen was also produced (eqn (4)) in addition to OH[•] owing to ozone formation. Moreover, decomposition of H₂O₂ through homolysis (eqn (5)) also yielded molecular oxygen.

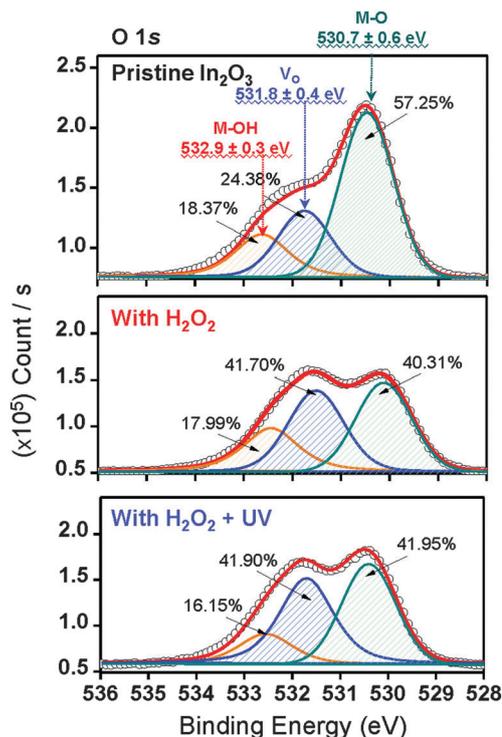
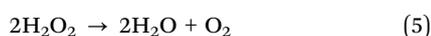
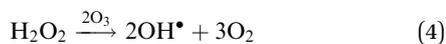


Fig. 4 Representative XPS O 1s peaks for pristine In₂O₃, In₂O₃-H₂O₂, and In₂O₃-HRA TFTs. The peaks were fitted representing metal hydroxides (M-OH; 532.9 ± 0.3 eV), oxygen deficiencies (V_O; 531.8 ± 0.4 eV), and metal oxides (M-O; 530.7 ± 0.6 eV).

Therefore incorporation of oxygen through the HRA method elevated the oxygen content in the lattice as expected. This relationship between oxygen supply and oxygen deficiency formation energy implies that the increase of V_O observed is due to the additional oxygen supply and not due to defect creation. The quantitative analyses by XPS verify this incorporation of oxygen, showing an increase in the total atomic ratios of oxygen in Fig. 5b.

As a simple method that enables both improved mobility and bias stability of In₂O₃ TFTs, we introduced OH[•] during the film formation process by adding and activating H₂O₂. The formation

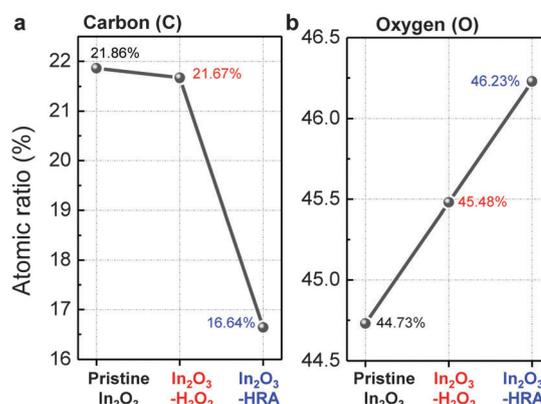


Fig. 5 Summarized atomic ratio of (a) carbon and (b) oxygen.



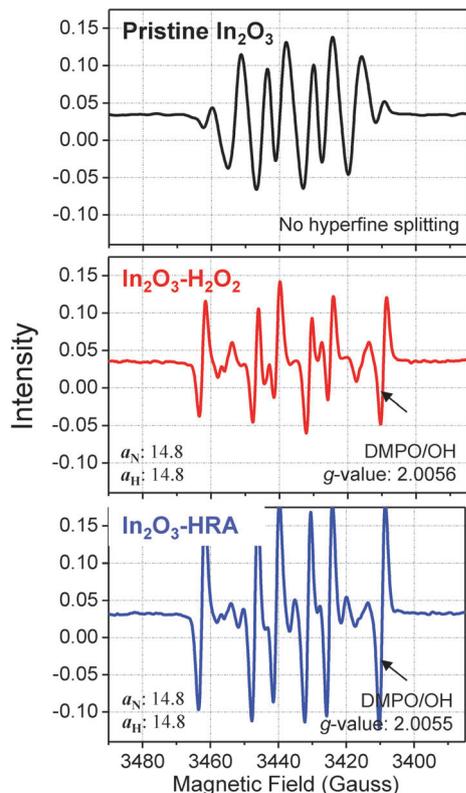


Fig. 6 ESR spectra of hydroxyl radicals as detected by the DMPO/OH adduct.

of OH^\bullet was confirmed by ESR spectroscopy (Fig. 6) using a spin trap agent, 5,5-dimethyl-1-pyrroline *N*-oxide (DMPO). The use of a spin trap agent was necessary due to the transient and short-lived nature of the radicals.³⁰ In Fig. 6, the intensity of DMPO/OH spectra of the In_2O_3 -HRA film was superior to that of In_2O_3 - H_2O_2 . The DMPO/OH spectra are characterized by *g*-factors of 2.0056 (In_2O_3 - H_2O_2) and 2.0055 (In_2O_3 -HRA), splitting by one ^{14}N nucleus ($a_{\text{N}} = 14.8$ G) and one ^1H nucleus ($a_{\text{H}} = 14.8$ G), respectively.³¹ This result verify that UV illumination is critical to generate a significant amount of OH^\bullet , as expected in eqn (1).

The incorporation of OH^\bullet into In_2O_3 synthesis is advantageous for the following two reasons.

(i) OH^\bullet as a decomposition agent

The generation of OH^\bullet in a precursor solution is capable of breaking down organic substrates into smaller molecules. Fig. 7 shows the proposed reaction scheme of HRA decomposition and oxidation. Because organic molecules in the precursor solution primarily originate from the solvent, it is therefore important to focus on the chemical composition of 2-methoxyethanol. Such alkoxyethanols possess two functional groups: (1) alcoholic hydroxyl ($-\text{OH}$) and (2) etheric oxy ($-\text{O}-$) groups.³² Ross and co-workers suggested that oxidation in 2-methoxyethanol occurs through electron transfer at the etheric oxy group rather than the hydroxyl group.³³ Upon generation of OH^\bullet from H_2O_2 , the unpaired electron from OH^\bullet is discharged at the etheric oxygen which is followed by fission of the C-C and/or C-H bonds between the oxygen atoms. Subsequently, the chain is further degraded leading to the cleavage of $-\text{O}-\text{CH}_2-\text{CH}_2$. The reaction produces cation I and formaldehyde II. Then cation I and formaldehyde II are oxidized to yield ethyl formate III and aldehyde IV respectively.³⁴ These smaller molecules can be effectively evaporated, resulting in reduced impurities. The specifics of electron transfer are challenging, but the products obtained indicate that the overall process, probably occurring in a series of steps, is one in which OH^\bullet oxidizes etheric oxygen and breaks down the methyl group into smaller formaldehyde. With more OH^\bullet available for transfer of electrons to the etheric oxy group,³³ ultimately oxidizing a carbon atom, a significant decrease in carboxylic groups was observed in the end film.

(ii) OH^\bullet as an oxidizing agent

OH^\bullet can oxidize sub-gap states from a near conduction band minimum (CBM) state to shallow states, shown in Fig. 8. In amorphous oxides, the states can be located above the valence band maximum (VBM, near-VBM) and below the CBM (near-VBM).³⁵ In the near-VBM state, the localized states are reportedly occupied by electron-acceptors which consist of oxygen sites and low valence cations (In^{3+} from In 4d and 5s).¹³ In the near-CBM state, on the

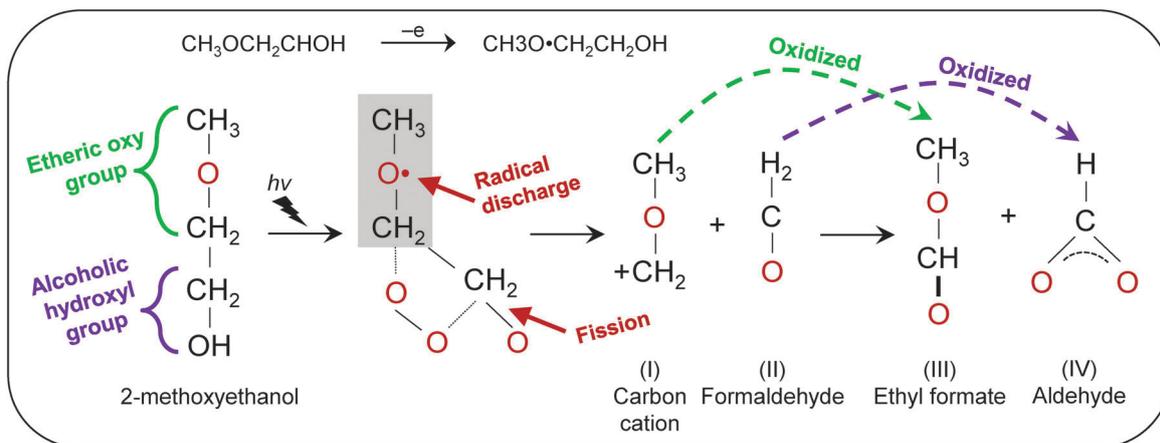


Fig. 7 Proposed reaction scheme of the hydroxyl radical-assisted decomposition of solution with 2-methoxyethanol solvent.



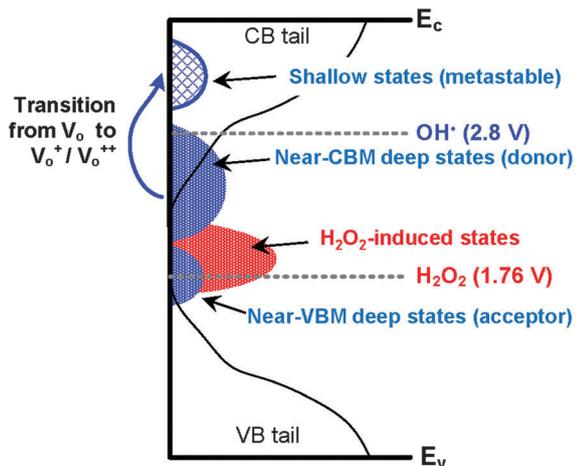


Fig. 8 Schematic illustrations of the hydroxyl-radical assisted oxidation inducing metastable states.

other hand, the band consists of electron-donors. The donor-type states are occupied at a neutral charge and can provide electrons by ionization. Fig. 8 shows the schematic illustrations of HRA oxidation that converts neutral near-CBM states to shallow states. It is commonly accepted that V_o in In_2O_3 are donors, owing to the high density of oxygen sites very close to and just below the CBM.³⁵ In the neutral charge state, V_o in the near-CBM states exhibit inward relaxation by binding two electrons. For $In_2O_3-H_2O_2$, the incorporation of H_2O_2 is expected to induce states located near-VBM, which are electron acceptors. In contrast, for In_2O_3-HRA , the incorporation of high density OH^\bullet is expected to chemically ionize the neutral V_o to give rise to the singly ionized state (V_o^+) and the doubly ionized state (V_o^{++}) due to its strong oxidation potential.²¹ Both of the ionized states are metastable because they are located above the CBM, and are therefore capable of both trapping and donating electrons.³⁶ For the In_2O_3-HRA TFT, our results indicate that electron donor behavior is more dominant for these metastable states.

Conclusions

In summary, we have demonstrated In_2O_3 TFTs exhibiting improved mobility and bias stabilities via a hydroxyl radical-assisted decomposition and oxidation approach. In the thin film formation, hydroxyl radicals reduce carbon impurities and induce the formation of metastable states. In addition, the low annealing temperature that was demonstrated indicates potential for manipulating oxidizing agents in pursuit of low-temperature and high-performance solution-based flexible oxide electronics at low manufacturing cost.

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